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XC7SH14

Inverting Schmitt trigger

Rev. 01 — 1 September 2009

Product data sheet

1. General description

XC7SH14 is a high-speed Si-gate CMOS device. It provides an inverting buffer function with Schmitt trigger action. This device is capable of transforming slowly changing input signals into sharply defined, jitter-free output signals.

2. Features

- Symmetrical output impedance
- High noise immunity
- ESD protection:
 - ◆ HBM JESD22-A114E: exceeds 2000 V
 - MM JESD22-A115-A: exceeds 200 V
 - ◆ CDM JESD22-C101C: exceeds 1000 V
- Low power dissipation
- Balanced propagation delays
- SOT353-1 and SOT753 package options
- Specified from -40 °C to +125 °C

3. Applications

- Wave and pulse shapers
- Astable multivibrators
- Monostable multivibrators

4. Ordering information

Table 1. Ordering information

Type number	Package		Package											
	Temperature range	Name	Description	Version										
XC7SH14GW	–40 °C to +125 °C	TSSOP5	plastic thin shrink small outline package; 5 leads; body width 1.25 mm	SOT353-1										
XC7SH14GV	–40 °C to +125 °C	SC-74A	plastic surface-mounted package; 5 leads	SOT753										



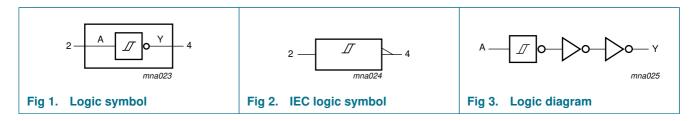
5. Marking

Table 2. Marking codes

Type number	Marking code ^[1]
XC7SH14GW	fF
XC7SH14GV	f14

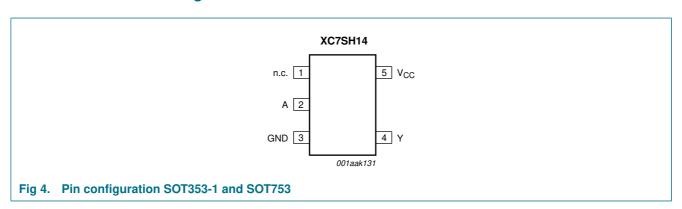
^[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

6. Functional diagram



7. Pinning information

7.1 Pinning



7.2 Pin description

Table 3. Pin description

Symbol	Pin	Description
n.c.	1	not connected
Α	2	data input
GND	3	ground (0 V)
Υ	4	data output
V _{CC}	5	supply voltage

XC7SH14_1 © NXP B.V. 2009. All rights reserved.

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8. Functional description

Table 4. Function table

H = HIGH voltage level; L = LOW voltage level

Input	Output
Α	Υ
L	Н
Н	L

9. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+7.0	V
V _I	input voltage		-0.5	+7.0	V
I _{IK}	input clamping current	$V_1 < -0.5 V$	-20	-	mA
I _{OK}	output clamping current	$V_O < -0.5 \text{ V or } V_O > V_{CC} + 0.5 \text{ V}$	<u>[1]</u> -	±20	mA
Io	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$	-	±25	mA
I _{CC}	supply current		-	75	mA
I_{GND}	ground current		–75	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$	[2] _	250	mW

^[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

10. Recommended operating conditions

Table 6. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CC}	supply voltage		2.0	5.0	5.5	V
VI	input voltage		0	-	5.5	V
Vo	output voltage		0	-	V_{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	°C

^[2] For both TSSOP5 and SC-74A packages: above 87.5 °C the value of Ptot derates linearly with 4.0 mW/K.

11. Static characteristics

Table 7. Static characteristics

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C	to +85 °C	–40 °C t	Unit	
			Min	Тур	Max	Min	Max	Min	Max	1
V_{OH}	HIGH-level	$V_I = V_{T+}$ or V_{T-}								
	output voltage	$I_O = -50 \mu A$; $V_{CC} = 2.0 \text{ V}$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_O = -50 \ \mu A; \ V_{CC} = 3.0 \ V$	2.9	3.0	-	2.9	-	2.9	-	V
		$I_O = -50 \ \mu A; \ V_{CC} = 4.5 \ V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_O = -4.0 \text{ mA}$; $V_{CC} = 3.0 \text{ V}$	2.58	-	-	2.48	-	2.40	-	V
		$I_O = -8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.94	-	-	3.8	-	3.70	-	V
V_{OL}	LOW-level output voltage	$V_I = V_{T+}$ or V_{T-}								
		$I_O = 50 \mu A; V_{CC} = 2.0 V$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 50 \mu A; V_{CC} = 3.0 V$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 50 \mu A; V_{CC} = 4.5 V$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.36	-	0.44	-	0.55	V
		$I_O = 8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.36	-	0.44	-	0.55	V
II	input leakage current	$V_I = 5.5 \text{ V or GND};$ $V_{CC} = 0 \text{ V to } 5.5 \text{ V}$	-	-	0.1	-	1.0	-	2.0	μΑ
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	1.0	-	10	-	40	μΑ
Cı	input capacitance		-	1.5	10	-	10	-	10	pF

11.1 Transfer characteristics

Table 8. Transfer characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V). See Figure 7 and Figure 8.

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	–40 °C to	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
V _{T+} positive- threshold voltage	positive-going	$V_{CC} = 3.0 \text{ V}$	-	-	2.2	-	2.2	-	2.2	٧
		$V_{CC} = 4.5 \text{ V}$	-	-	3.15	-	3.15	-	3.15	٧
	voitage	$V_{CC} = 5.5 \text{ V}$	-	-	3.85	-	3.85	-	3.85	٧
V_{T-}	negative-going threshold voltage	$V_{CC} = 3.0 \text{ V}$	0.9	-	-	0.9	-	0.9	-	V
		$V_{CC} = 4.5 \text{ V}$	1.35	-	-	1.35	-	1.35	-	V
		$V_{CC} = 5.5 \text{ V}$	1.65	-	-	1.65	-	1.65	-	V
V_{H}	hysteresis	$V_{CC} = 3.0 \text{ V}$	0.3	-	1.2	0.3	1.2	0.25	1.2	V
	voltage	$V_{CC} = 4.5 \text{ V}$	0.4	-	1.4	0.4	1.4	0.35	1.4	٧
		$V_{CC} = 5.5 \text{ V}$	0.5	-	1.6	0.5	1.6	0.45	1.6	٧

12. Dynamic characteristics

Table 9. Dynamic characteristics

GND = 0 V. For waveform see Figure 5. For test circuit see Figure 6.

Symbol	Parameter	Conditions			25 °C		–40 °C 1	to +85 °C	–40 °C to	Unit	
				Min	Тур	Max	Min	Max	Min	Max	
t_{pd}	propagation	A to Y;	<u>[1]</u>								
	delay	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	[2]								
		$C_L = 15 pF$		-	4.2	12.8	1.0	15.0	1.0	16.5	ns
		$C_L = 50 pF$		-	6.0	16.3	1.0	18.5	1.0	20.5	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	[3]								
		C _L = 15 pF		-	3.2	8.6	1.0	10.0	1.0	11.0	ns
		$C_L = 50 pF$		-	4.6	10.6	1.0	12.0	1.0	13.5	ns
C_{PD}	power dissipation capacitance	per buffer; $C_L = 50 \text{ pF}$; $f = 1 \text{ MHz}$; $V_I = \text{GND to } V_{CC}$	<u>[4]</u>	-	12	-	-	-	-	-	pF

- [1] t_{pd} is the same as t_{PLH} and t_{PHL} .
- [2] Typical values are measured at $V_{CC} = 3.3 \text{ V}$.
- [3] Typical values are measured at $V_{CC} = 5.0 \text{ V}$.
- [4] C_{PD} is used to determine the dynamic power dissipation P_D (μW).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz;

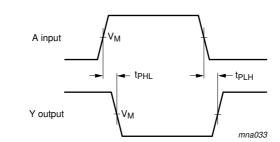
fo = output frequency in MHz;

C_L = output load capacitance in pF;

 V_{CC} = supply voltage in Volts.

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13. Waveforms

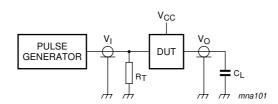


Measurement points are given in Table 10.

Fig 5. The input (A) to output (Y) propagation delays

Table 10. Measurement points

Type number	Input	Input						
	VI	V _M	V _M					
XC7SH14	GND to V _{CC}	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$					



Test data is given in Table 11.

Definitions for test circuit:

 C_L = Load capacitance including jig and probe capacitance.

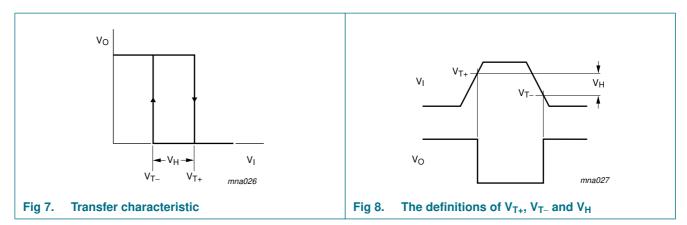
 R_T = Termination resistance should be equal to output impedance Z_0 of the pulse generator.

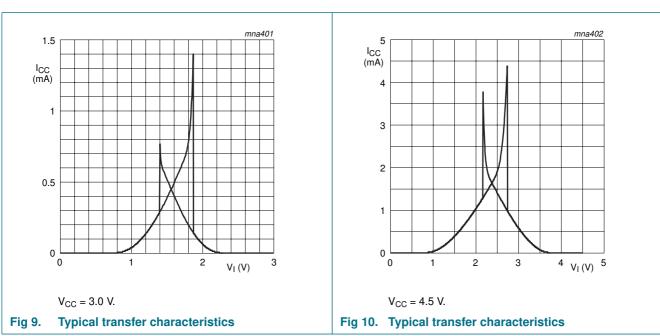
Fig 6. Load circuitry for switching times

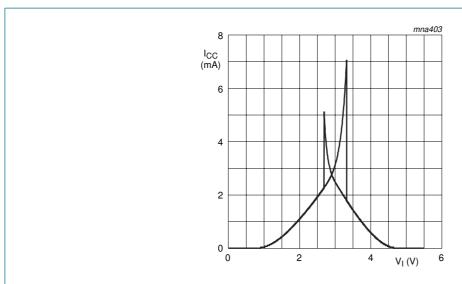
Table 11. Test data

Туре	Input		Load	Test
	V _I	t _r , t _f	CL	
XC7SH14	V _{CC}	≤ 3.0 ns	15 pF, 50 pF	t _{PLH} , t _{PHL}

13.1 Transfer characteristic waveforms







 $V_{CC} = 5.5 \text{ V}.$

Fig 11. Typical transfer characteristics

14. Application information

The slow input rise and fall times cause additional power dissipation, which can be calculated using the following formula:

 $P_{add} = f_i \times (t_r \times \Delta I_{CC(AV)} + t_f \times \Delta I_{CC(AV)}) \times V_{CC}$ where:

 P_{add} = additional power dissipation (μW);

 $f_i = input frequency (MHz);$

 t_r = input rise time (ns); 10 % to 90 %;

 t_f = input fall time (ns); 90 % to 10 %;

 $\Delta I_{CC(AV)}$ = average additional supply current (μA).

Average additional I_{CC} differs with positive or negative input transitions, as shown in Figure 12.

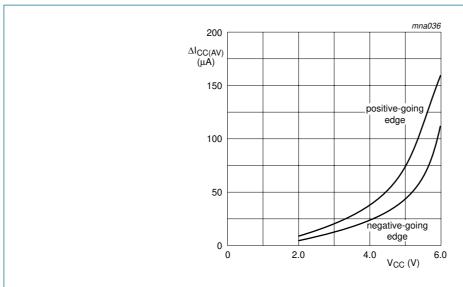
For XC7SH14 used in relaxation oscillator circuit, see Figure 13.

Note to the application information:

1. All values given are typical unless otherwise specified.

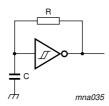
NXP Semiconductors XC7SH14

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Linear change of V_{I} between $0.1V_{CC}$ to $0.9V_{CC}$

Fig 12. Average additional I_{CC}



$$f = \frac{1}{T} \approx \frac{1}{0.55 \times RC}$$

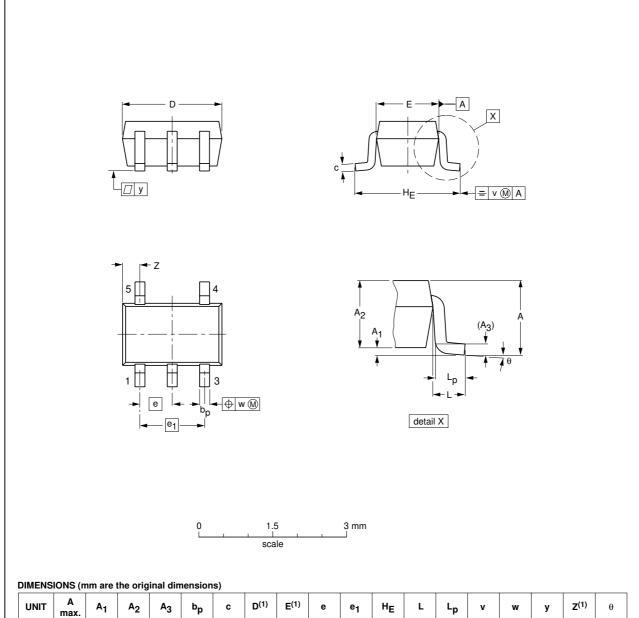
Fig 13. Relaxation oscillator using the XC7SH14

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15. Package outline

TSSOP5: plastic thin shrink small outline package; 5 leads; body width 1.25 mm

SOT353-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	e ₁	HE	L	Lp	v	w	у	Z ⁽¹⁾	θ
mm	1.1	0.1 0	1.0 0.8	0.15	0.30 0.15	0.25 0.08	2.25 1.85	1.35 1.15	0.65	1.3	2.25 2.0	0.425	0.46 0.21	0.3	0.1	0.1	0.60 0.15	7° 0°

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

VERSION IEC JEDEC JEITA PROJECTION SOT353-1 MO-203 SC-88A IIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIII	OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE
SU1353-1 MU-203 SU-88A +	VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
- 4 03-02-19	SOT353-1		MO-203	SC-88A			00-09-01 03-02-19

Fig 14. Package outline SOT353-1 (TSSOP5)

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Plastic surface-mounted package; 5 leads

SOT753

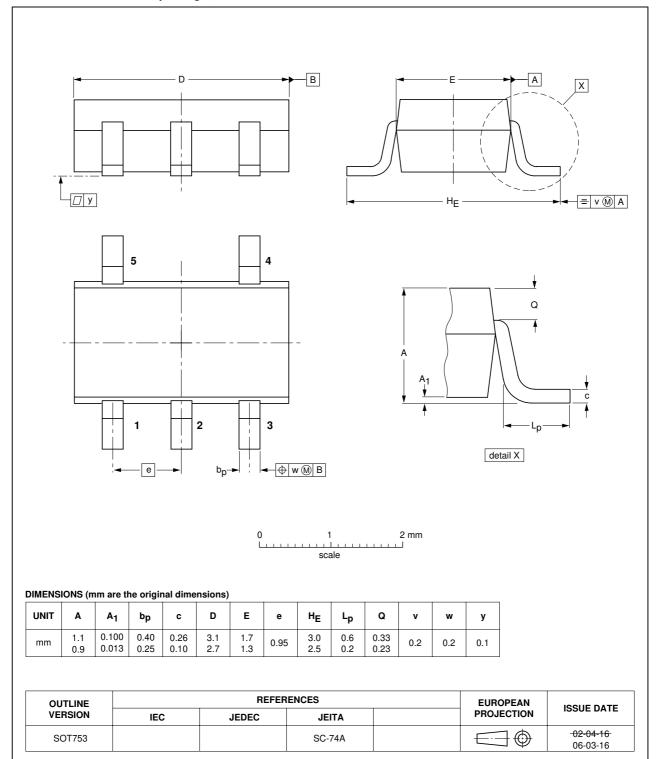


Fig 15. Package outline SOT753 (SC-74A)

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16. Abbreviations

Table 12. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

17. Revision history

Table 13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
XC7SH14_1	20090901	Product data sheet	-	-

18. Legal information

18.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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